

## LTC1350

## 3.3V Low Power EIA/TIA-562 3-Driver/ 5-Receiver Transceiver

#### **FEATURES**

- Low Supply Current: 300µA
  Receivers 4 and 5 Kept Alive in Shutdown: 35µA
- ESD Protection: ±10kV
- Operates from a Single 3.3V Supply
- Uses Small Capacitors: 0.1µF
- Operates to 120kBaud
- Three-State Outputs are High Impedance When Off
- Output Overvoltage Does Not Force Current Back into Supplies
- EIA/TIA-562 I/O Lines Can Be Forced to ±25V
  Without Damage
- Flowthrough Architecture

## **APPLICATIONS**

- Notebook Computers
- Palmtop Computers

### DESCRIPTION

The LTC®1350 is a 3-driver/5-receiver EIA/TIA-562 transceiver with very low supply current. In the no load condition, the supply current is only  $300\mu A$ . The charge pump only requires four  $0.1\mu F$  capacitors.

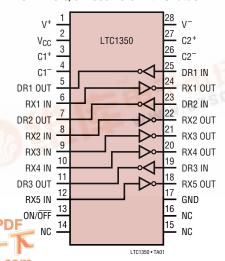
In Shutdown mode, two receivers are kept alive and the supply current is only  $35\mu A$ . All RS232 outputs assume a high impedance state in Shutdown or with the power off.

The LTC1350 is fully compliant with all data rate and overvoltage EIA/TIA-562 specifications. The transceiver can operate up to 120kbaud with a 1000pF and  $3k\Omega$  load. Both driver outputs and receiver inputs can be forced to  $\pm 25V$  without damage and can survive multiple  $\pm 10kV$  ESD strikes.

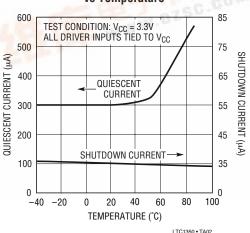
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## TYPICAL APPLICATION

#### 3-Drivers/5-Receivers with Shutdown



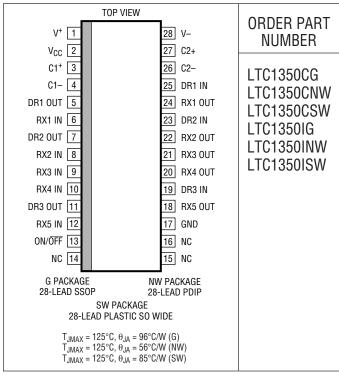
## Quiescent and Shutdown Supply Current vs Temperature



## **ABSOLUTE MAXIMUM RATINGS**

Supply Voltage (V <sub>CC</sub> ) 5	V
Input Voltage	
Driver $-0.3V$ to $V_{CC} + 0.3$	
Receiver25V to 25	V
$ON/\overline{OFF}$ Pin $-0.3V$ to $V_{CC}$ + 0.3	V
Output Voltage	
Driver –25V to 25	V
Receiver $-0.3V$ to $V_{CC} + 0.3$	V
Short-Circuit Duration	
V+ 30 se	90
V <sup>-</sup> 30 se	96
Driver Output Indefinit	te
Receiver Output Indefinit	te
Operating Temperature Range	
Commercial (LTC1350C) 0°C to 70°	C
Industrial (LTC1350I)40°C to 85°	C
Storage Temperature Range65°C to 150°	C
Lead Temperature (Soldering, 10 sec) 300°	С

## PACKAGE/ORDER INFORMATION



Consult LTC Marketing for parts specified with wider operating temperature ranges.

# **DC ELECTRICAL CHARACTERISTICS** The $\bullet$ denotes specifications which apply over the full operating temperature range. $V_{CC}=3.3V$ , $C1=C2=C3=C4=0.1\mu F$ , unless noted.

PARAMETER	CONDITIONS			MIN	TYP	MAX	UNITS
Any Driver							
Output Voltage Swing	3k to GND	Positive	•	3.7	4.5		V
		Negative	•	-3.7	-4.5		V
Logic Input Voltage Level	Input Low Level (V <sub>OUT</sub> = High)		•		1.4	0.8	V
	Input High Level (V <sub>OUT</sub> = Low)		•	2.0	1.4		V
Logic Input Current	$V_{IN} = V_{CC}$		•			5	μA
	$V_{IN} = 0V$		•			-5	μA
Output Short-Circuit Current	V <sub>OUT</sub> = 0V			±9	±10		mA
Output Leakage Current	Shutdown (Note 3), V <sub>OUT</sub> = ±20V				10	500	μΑ
Any Receiver			·				
Input Voltage Thresholds	Input Low Threshold		•	0.8	1.3		V
	Input High Threshold		•		1.7	2.4	V
Hysteresis			•	0.1	0.4	1	V
Input Resistance	$V_{IN} = \pm 10V$			3	5	7	kΩ
Output Voltage	Output Low, I <sub>OUT</sub> = -1.6mA (V <sub>CC</sub> = 3	3.3V)	•		0.2	0.4	V
	Output High, $I_{OUT} = 160\mu A$ ( $V_{CC} = 3$ .	3V)	•	3.0	3.2		V
Output Short-Circuit Current	Sinking Current, V <sub>OUT</sub> = V <sub>CC</sub>			-3	-20		mA
Output Leakage Current	Shutdown (Note 3), $0V \le V_{OUT} \le V_{CO}$	;	•		1	10	μΑ

## **DC ELECTRICAL CHARACTERISTICS** The $\bullet$ denotes specifications which apply over the full operating temperature range. $V_{CC} = 3.3V$ , $C1 = C2 = C3 = C4 = 0.1 \mu F$ , unless noted.

PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
Power Supply Generator						
V <sup>+</sup> Output Voltage	I <sub>OUT</sub> = 0mA			5.7		V
	$I_{OUT} = 5mA$			5.5		V
V <sup>-</sup> Output Voltage	$I_{OUT} = 0mA$			-5.3		V
	$I_{OUT} = -5mA$			-5.0		V
Supply Rise Time	Shutdown to Turn-On			0.2		ms
Power Supply		'				
V <sub>CC</sub> Supply Current	No Load (All Drivers $V_{IN} = V_{CC}$ )(Note 2) $0^{\circ}C \le T_A \le 70^{\circ}C$	•		0.3	0.6	mA
	No Load (All Drivers $V_{IN} = 0$ )(Note 2) $0^{\circ}C \le T_A \le 70^{\circ}C$	•		0.5	1.0	mA
	No Load (All Drivers $V_{IN} = V_{CC}$ )(Note 2) $0^{\circ}C \le T_A \le 85^{\circ}C$	•		0.3	1.0	mA
	No Load (All Drivers $V_{IN} = V_{CC}$ )(Note 2) $-40^{\circ}$ C $\leq T_A \leq 0^{\circ}$ C	•		0.3	1.5	mA
	No Load (All Drivers $V_{IN} = 0$ )(Note 2) $-40^{\circ}$ C $\leq T_A \leq 85^{\circ}$ C	•		0.5	1.5	mA
	Shutdown (Note 3)	•		35	50	μА
ON/OFF Threshold Low		•		1.4	0.8	V
ON/OFF Threshold High		•	2.0	1.4		V

# **AC CHARACTERISTICS** The $\bullet$ denotes specifications which apply over the full operating temperature range. $V_{CC}=5V,\ C1=C2=C3=C4=0.1\mu F,\ unless\ noted.$

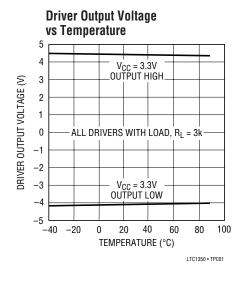
PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
Slew Rate	$R_L = 3k, C_L = 51pF$			8	30	V/µs
	$R_L = 3k, C_L = 1000pF$		3	5		V/µs
Driver Propagation Delay	t <sub>HLD</sub> (Figure 1)	•		2	3.5	μS
(TTL to EIA/TIA-562)	t <sub>LHD</sub> (Figure 1)			2	3.5	μS
Receiver Propagation Delay	t <sub>HLR</sub> (Figure 2)	•		0.3	0.8	μS
(EIA/TIA-562 to TTL)	t <sub>LHR</sub> (Figure 2)	•		0.3	8.0	μS

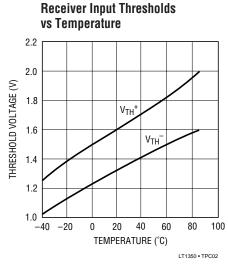
**Note 1:** Absolute Maximum Ratings are those values beyond which the life of the device may be impaired.

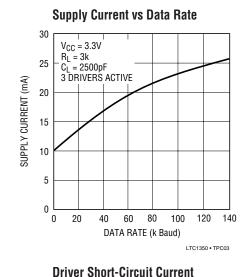
**Note 2:** Supply current is measured with driver and receiver outputs unloaded.

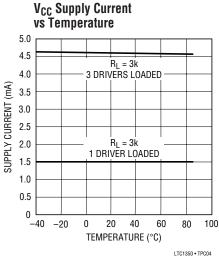
Note 3: Supply current measurement in Shutdown mode is performed with  $V_{\text{ON/\overline{OFF}}}$  = 0V.

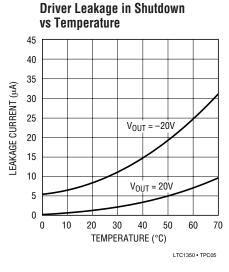
## TYPICAL PERFORMANCE CHARACTERISTICS

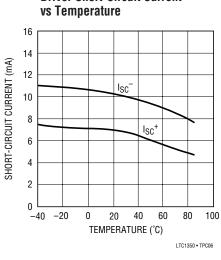


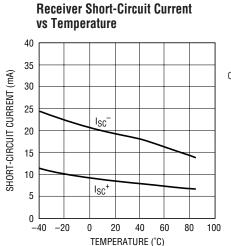




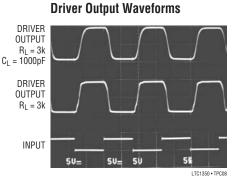


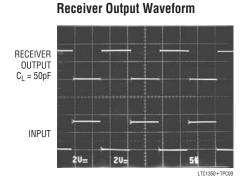






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#### PIN FUNCTIONS

**V<sub>CC</sub>:** 3.3V Input Supply Pin. Supply current is typically 35μA in the Shutdown mode. This pin should be decoupled with a 0.1μF ceramic capacitor.

GND: Ground Pin.

**ON/OFF:** TTL/CMOS Compatible Shutdown Pin. A logic low puts the device in the Shutdown mode with receivers 4 and 5 kept alive and the supply current equal to  $35\mu$ A. All driver and other receiver outputs are in high impedance state. This pin cannot float.

**V+:** Positive Supply Output.  $V^+ \cong 2V_{CC} - 1V$ . This pin requires an external capacitor ( $C = 0.1\mu F$ ) for charge storage. The capacitor may be tied to ground or  $V_{CC}$ . With multiple devices, the  $V^+$  and  $V^-$  pins may be paralleled into common capacitors. For a large number of devices, increasing the size of the shared common storage capacitors is recommended to reduce ripple.

**V**<sup>-</sup>: Negative Supply Output.  $V^- = -(2V_{CC} - 1.3V)$ . This pin requires an external capacitor ( $C = 0.1 \mu F$ ) for charge storage.

C1+, C1-, C2+, C2-: Commutating Capacitor Inputs. These pins require two external capacitors ( $C = 0.1 \mu F$ ): one from C1+ to C1- and another from C2+ to C2-. To maintain charge pump efficiency, the capacitor's effective series resistance should be less than  $20\Omega$ .

**DR IN:** EIA/TIA-562 Driver Input Pins. Inputs are TTL/CMOS compatible. Inputs should not be allowed to float. Tie unused inputs to  $V_{CC}$ .

**DR OUT:** Driver Outputs at EIA/TIA-562 Voltage Levels. Outputs are in a high impedance state when in the Shutdown mode or  $V_{CC}$  = 0V. The driver outputs are protected against ESD to  $\pm 10$ kV for human body model discharges.

**RX IN:** Receiver Inputs. These pins can be forced to  $\pm 25$ V without damage. The receiver inputs are protected against ESD to  $\pm 10$ kV for human body model discharges. Each receiver provides 0.4V of hysteresis for noise immunity.

**RX OUT:** Receiver Outputs with TTL/CMOS Voltage Levels. Receiver 1, 2 and 3 outputs are in a high impedance state when in Shutdown mode to allow data line sharing. Receivers 4 and 5 are kept alive in Shutdown.

## **SWITCHING TIME WAVEFORMS**

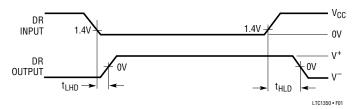


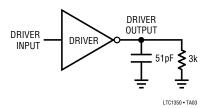
Figure 1. Driver Propagation Delay Timing



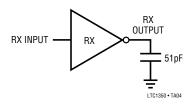
Figure 2. Receiver Propagation Delay Timing

## **TEST CIRCUITS**

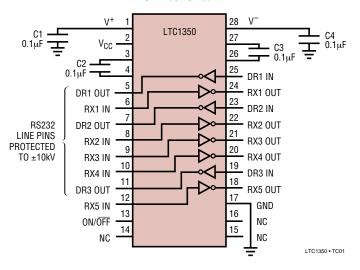
#### **Driver Timing Test Load**



#### **Receiver Timing Test Load**



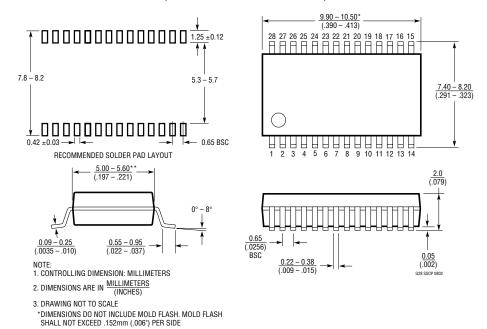
#### **ESD Test Circuit**



## PACKAGE DESCRIPTION

#### G Package 28-Lead Plastic SSOP (5.3mm)

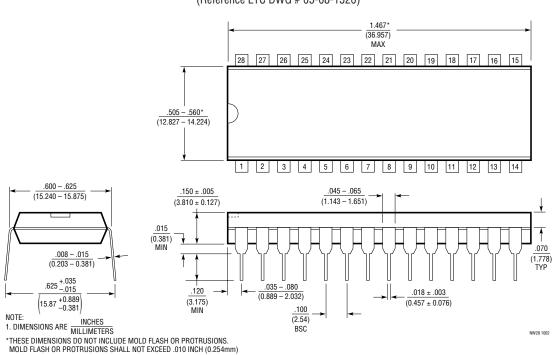
(Reference LTC DWG # 05-08-1640)



#### **NW Package** 28-Lead PDIP (Wide .600 Inch)

\*\*DIMENSIONS DO NOT INCLUDE INTERLEAD FLASH. INTERLEAD FLASH SHALL NOT EXCEED .254mm (.010") PER SIDE

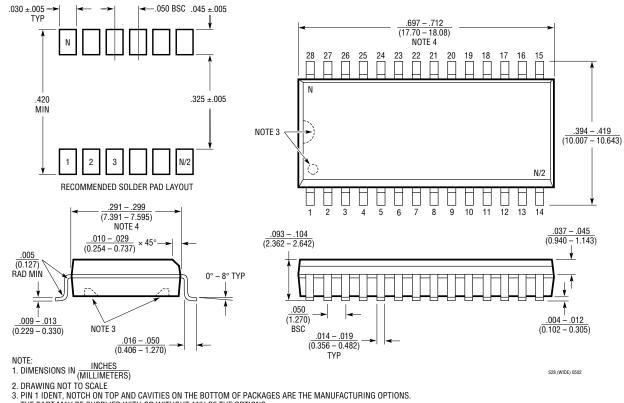
(Reference LTC DWG # 05-08-1520)



## PACKAGE DESCRIPTION

#### **SW Package** 28-Lead Plastic Small Outline (Wide .300 Inch)

(Reference LTC DWG # 05-08-1620)



- THE PART MAY BE SUPPLIED WITH OR WITHOUT ANY OF THE OPTIONS 4. THESE DIMENSIONS DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED .006" (0.15mm)

## **RELATED PARTS**

PART NUMBER	DESCRIPTION	COMMENTS
LT®1137A	5V, 3 Driver, 5 Receiver RS232 Transceiver	±15kV ESD per IEC 1000-4
LTC1327	3.3V, 3 Driver, 5 Receiver RS562 Transceiver	300μA Supply Current, 0.2μA in Shutdown
LTC1337	5V, 3 Driver, 5 Receiver RS232 Transceiver	300μA Supply Current, 1μA in Shutdown
LTC1348	3.3V to 5V, 3 Driver, 5 Receiver RS232 Transceiver	True RS232 on 3.3V, 5 Receivers Active in Shutdown
LTC1385	3.3V, 2 Driver, 2 Receiver RS562 Transceiver	200µA Supply Current, 2 Receivers Active in Shutdown
LTC1386	3.3V, 2 Driver, 2 Receiver RS562 Transceiver	200µA Supply Current, Narrow 16-Pin SO
LTC2844	3.3V, Software-Selectable Multiprotocol Transceiver	4 Drivers, 4 Receivers for Control Signals Including LL
LTC2845	3.3V, Software-Selectable Multiprotocol Transceiver	5 Drivers, 5 Receivers for Control Signals Including LL, RL and TM
LTC2846	3.3V, Software-Selectable Multiprotocol Transceiver	4 Drivers, 4 Receivers with Termination for Data/Clock